

$V_{DRM}$  = 4500 V  
 $I_{TGQM}$  = 4000 A  
 $I_{TSM}$  =  $25 \times 10^3$  A  
 $V_{TO}$  = 1.2 V  
 $r_T$  = 0.65 mW  
 $V_{Dclink}$  = 2800 V

# Asymmetric Gate turn-off Thyristor **5SGF 40L4502**

Doc. No. 5SYA1209-04 Feb. 05

- Patented free-floating silicon technology
- Low on-state and switching losses
- Annular gate electrode
- Industry standard housing
- Cosmic radiation withstand rating

## Blocking

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Repetitive peak off-state voltage	$V_{DRM}$	$V_{GR} \geq 2$ V			4500	V
Repetitive peak reverse voltage	$V_{RRM}$				17	V
Permanent DC voltage for 100 FIT failure rate	$V_{Dclink}$	Ambient cosmic radiation at sea level in open air.			2800	V

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Repetitive peak off-state current	$I_{DRM}$	$V_D = V_{DRM}$ , $V_{GR} \geq 2$ V			100	mA
Repetitive peak reverse current	$I_{RRM}$	$V_R = V_{RRM}$ , $R_{GK} = \infty \Omega$			50	mA

## Mechanical data

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	$F_m$		36	40	44	kN

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Pole-piece diameter	$D_p$	$\pm 0.1$ mm		75		mm
Housing thickness	$H$		26.0		26.5	mm
Weight	$m$				1.5	kg
Surface creepage distance	$D_s$	Anode to Gate	33			mm
Air strike distance	$D_a$	Anode to Gate	14			mm

1) Maximum rated values indicate limits beyond which damage to the device may occur

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# GTO Data

## On-state

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. average on-state current	I <sub>T(AV)M</sub>	Half sine wave, T <sub>C</sub> = 85 °C			1180	A
Max. RMS on-state current	I <sub>T(RMS)</sub>				1850	A
Max. peak non-repetitive surge current	I <sub>TSM</sub>	t <sub>p</sub> = 10 ms, T <sub>vj</sub> = 125°C, sine wave After Surge: V <sub>D</sub> = V <sub>R</sub> = 0 V			25×10 <sup>3</sup>	A
Limiting load integral	I <sup>2</sup> t				3.1×10 <sup>6</sup>	A <sup>2</sup> s
Max. peak non-repetitive surge current	I <sub>TSM</sub>	t <sub>p</sub> = 1 ms, T <sub>vj</sub> = 125°C, sine wave After Surge: V <sub>D</sub> = V <sub>R</sub> = 0 V			40×10 <sup>3</sup>	A
Limiting load integral	I <sup>2</sup> t				800×10 <sup>3</sup>	A <sup>2</sup> s

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	V <sub>T</sub>	I <sub>T</sub> = 4000 A, T <sub>vj</sub> = 125°C			3.8	V
Threshold voltage	V <sub>(TO)</sub>	T <sub>vj</sub> = 125°C			1.2	V
Slope resistance	r <sub>T</sub>	I <sub>T</sub> = 400...5000 A			0.65	mΩ
Holding current	I <sub>H</sub>	T <sub>vj</sub> = 25°C			100	A

## Turn-on switching

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Critical rate of rise of on-state current	di <sub>T</sub> /dt <sub>cr</sub>	T <sub>vj</sub> = 125°C, f = 200 Hz			500	A/μs
Critical rate of rise of on-state current	di <sub>T</sub> /dt <sub>cr</sub>	I <sub>T</sub> = 4000 A, I <sub>GM</sub> = 50 A, di <sub>G</sub> /dt = 40 A/μs f = 1 Hz			1000	A/μs
Min. on-time	t <sub>on</sub>		100			μs

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Turn-on delay time	t <sub>d</sub>	V <sub>D</sub> = 0.5 V <sub>DRM</sub> , T <sub>vj</sub> = 125 °C			2.5	μs
Rise time	t <sub>r</sub>	I <sub>T</sub> = 4000 A, di <sub>T</sub> /dt = 300 A/μs, I <sub>GM</sub> = 50 A, di <sub>G</sub> /dt = 40 A/μs, C <sub>S</sub> = 6 μF, R <sub>S</sub> = 5 Ω			5	μs
Turn-on energy per pulse	E <sub>on</sub>				3	J

## Turn-off switching

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. controllable turn-off current	I <sub>TGQM</sub>	V <sub>DM</sub> ≤ V <sub>DRM</sub> , di <sub>GQ</sub> /dt = 40 A/μs, C <sub>S</sub> = 6 μF, L <sub>S</sub> ≤ 0.2 μH			4000	A
Min. off-time	t <sub>off</sub>		100			μs

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Storage time	t <sub>S</sub>	V <sub>D</sub> = 0.5 V <sub>DRM</sub> , T <sub>vj</sub> = 125 °C			25	μs
Fall time	t <sub>f</sub>	V <sub>DM</sub> ≤ V <sub>DRM</sub> , di <sub>GQ</sub> /dt = 40 A/μs, I <sub>TGQ</sub> = I <sub>TGQM</sub> , R <sub>S</sub> = 5Ω, C <sub>S</sub> = 6 μF, L <sub>S</sub> = 0.2 μH			3	μs
Turn-on energy per pulse	E <sub>off</sub>				10	J
Peak turn-off gate current	I <sub>GQM</sub>				1100	A

**Gate****Maximum rated values<sup>1)</sup>**

Parameter	Symbol	Conditions	min	typ	max	Unit
Repetitive peak reverse voltage	$V_{GRM}$				17	V
Repetitive peak reverse current	$I_{GRM}$	$V_{GR} = V_{GRM}$			20	mA

**Characteristic values**

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate trigger voltage	$V_{GT}$	$T_{vj} = 25^\circ C$ , $V_D = 24 V$ , $R_A = 0.1 \Omega$		1.2		V
Gate trigger current	$I_{GT}$			4		A

**Thermal****Maximum rated values<sup>1)</sup>**

Parameter	Symbol	Conditions	min	typ	max	Unit
Junction operating temperature	$T_{vj}$		-40		125	°C
Storage temperature range	$T_{stg}$		-40		125	°C

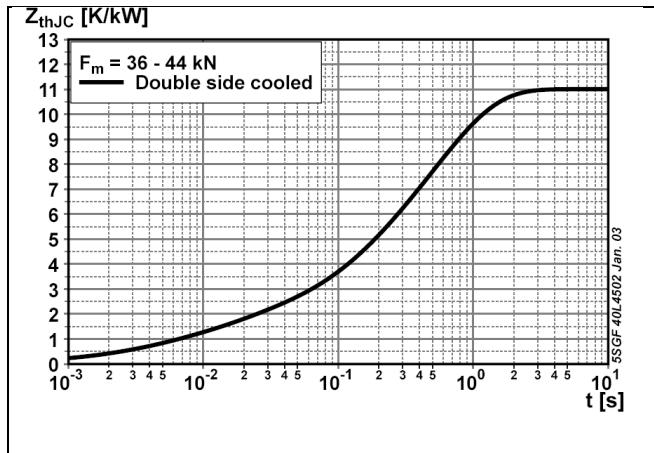
**Characteristic values**

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	$R_{th(jc)}$	Double side cooled			11	K/kW
	$R_{th(jc)A}$	Anode side cooled			20	K/kW
	$R_{th(jc)C}$	Cathode side cooled			25	K/kW
Thermal resistance case to heatsink (Double side cooled)	$R_{th(ch)}$	Single side cooled			6	K/kW
	$R_{th(ch)}$	Double side cooled			3	K/kW

**Analytical function for transient thermal impedance:**

$$Z_{thJC}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

i	1	2	3	4
$R_i(K/kW)$	7.766	1.728	1.064	0.450
$\tau_i(s)$	0.5764	0.1258	0.0128	0.0031



**Fig. 1** Transient thermal impedance, junction to case.

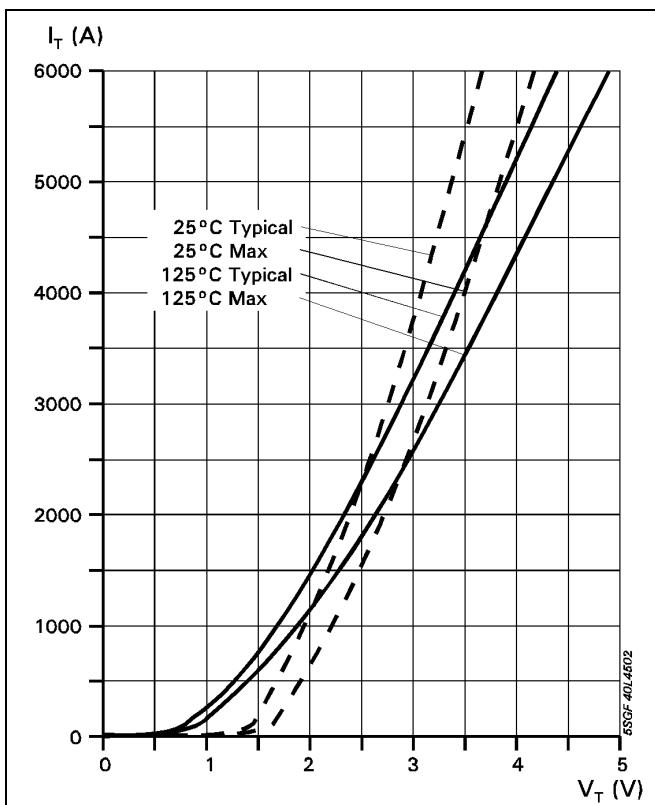


Fig. 2 On-state characteristics.

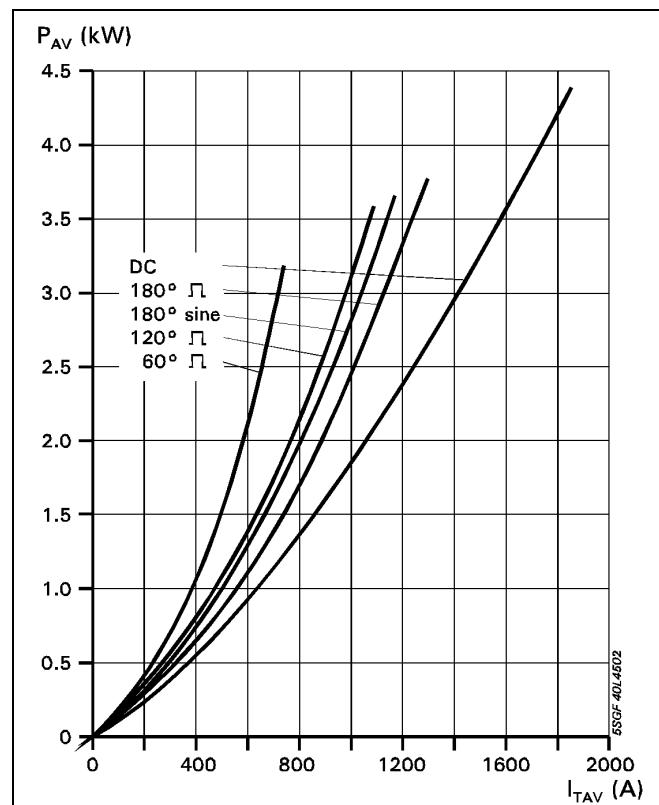


Fig. 3 Average on-state power dissipation vs. average on-state current.

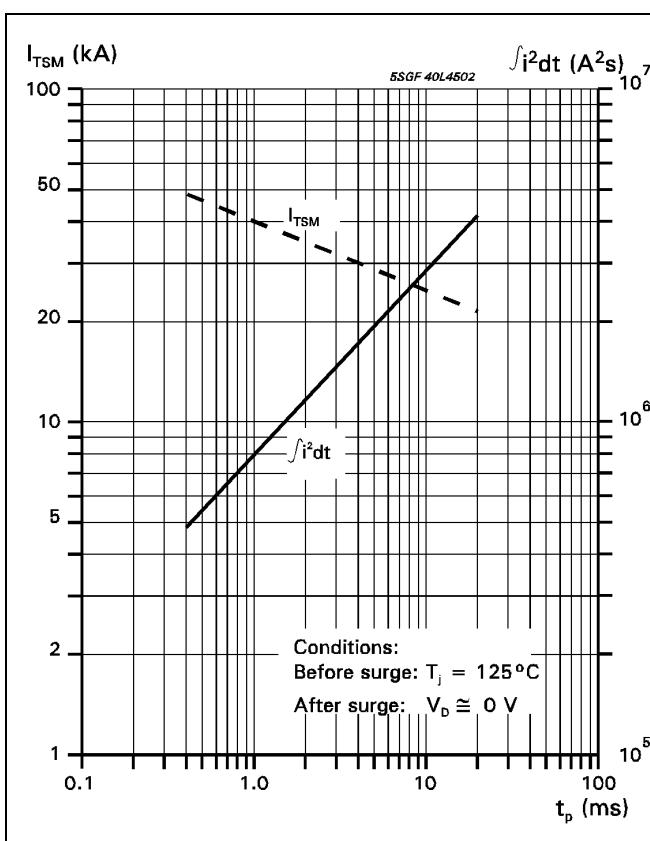
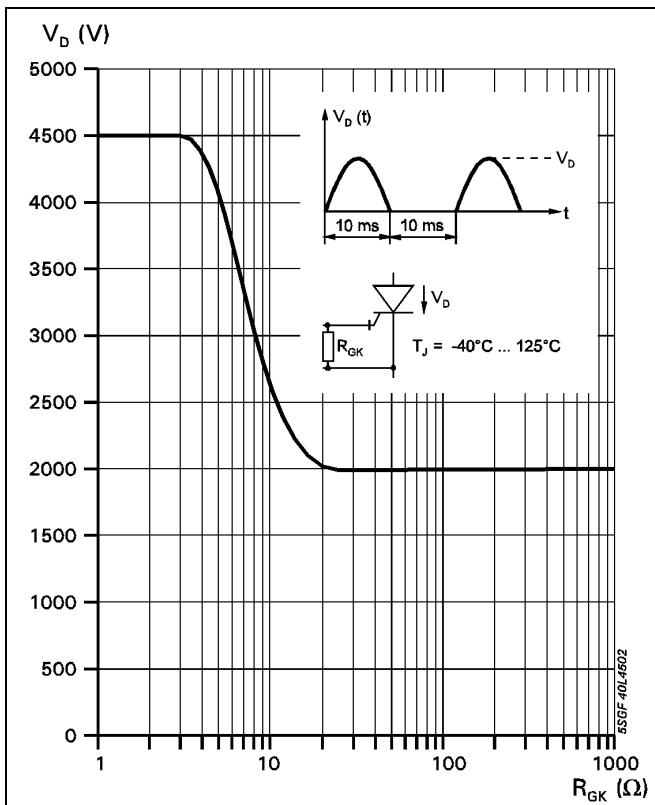
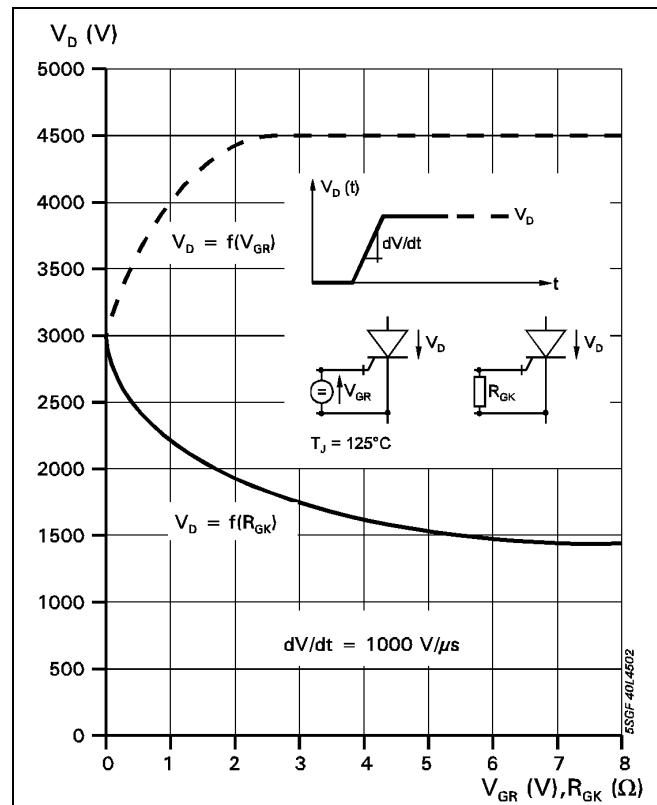


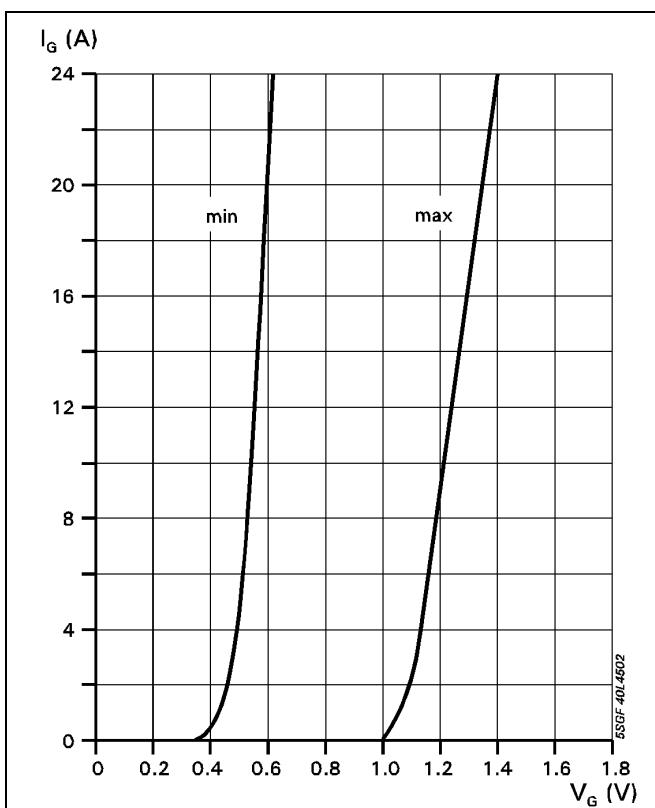
Fig. 4 Surge current and fusing integral vs. pulse width.



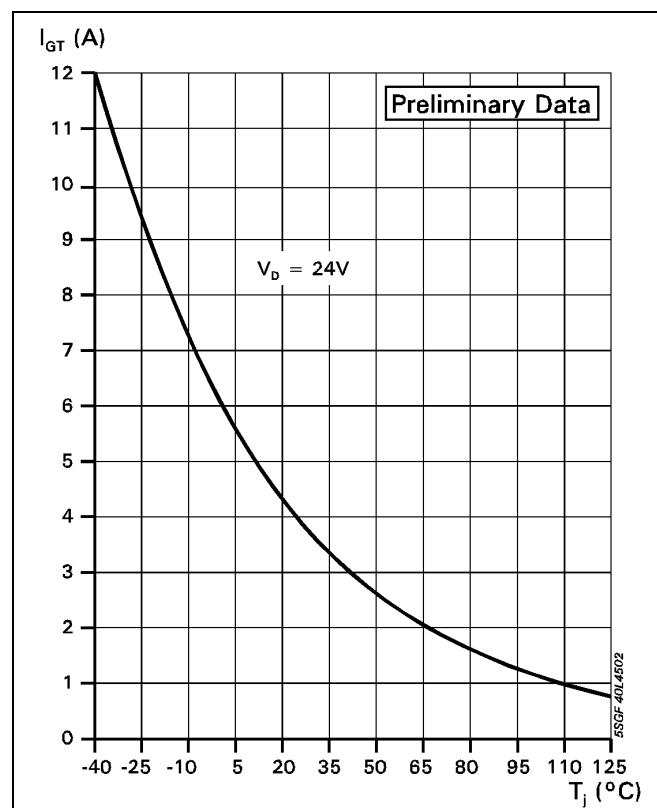
**Fig. 5** Forward blocking voltage vs. gate-cathode resistance.



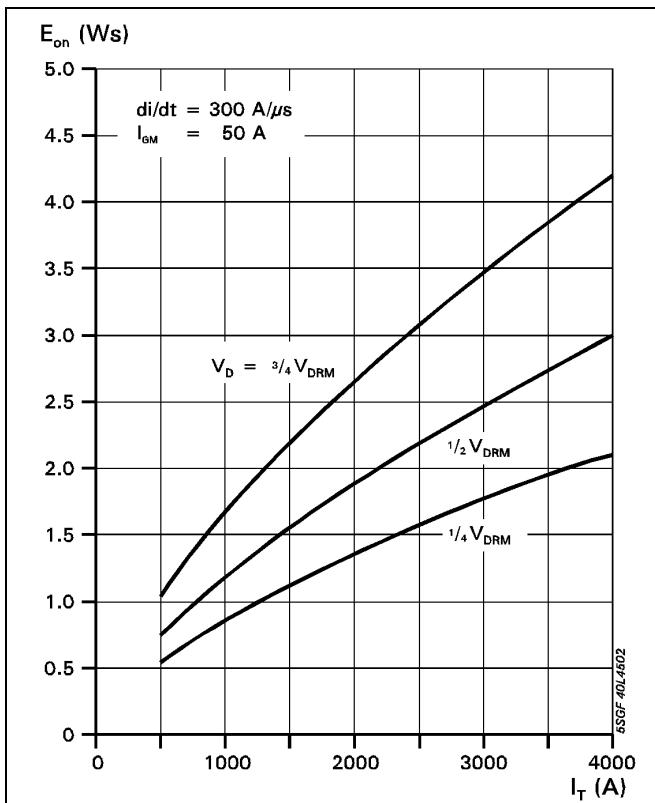
**Fig. 6** Static  $dv/dt$  capability: Forward blocking voltage vs. neg. gate voltage or gate cathode resistance.



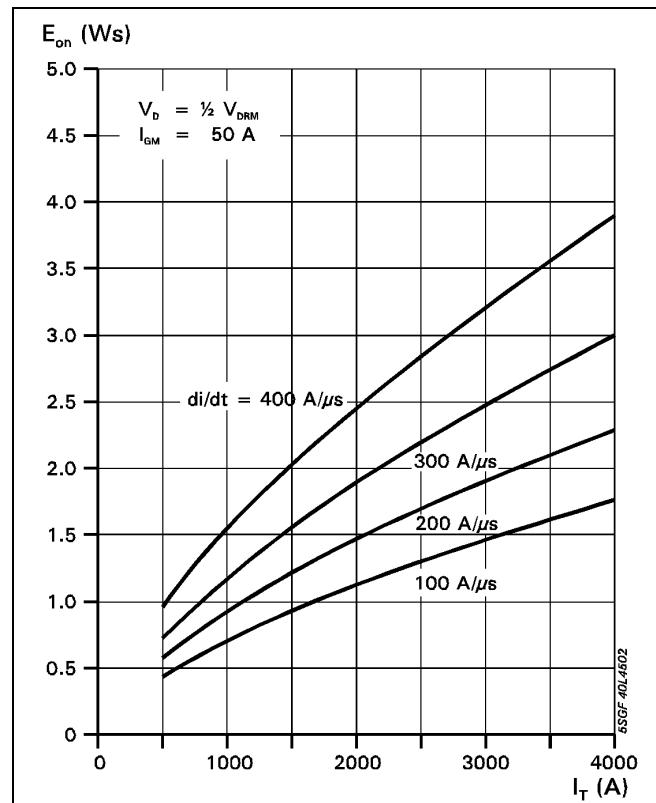
**Fig. 7** Forward gate current vs. forward gate voltage.



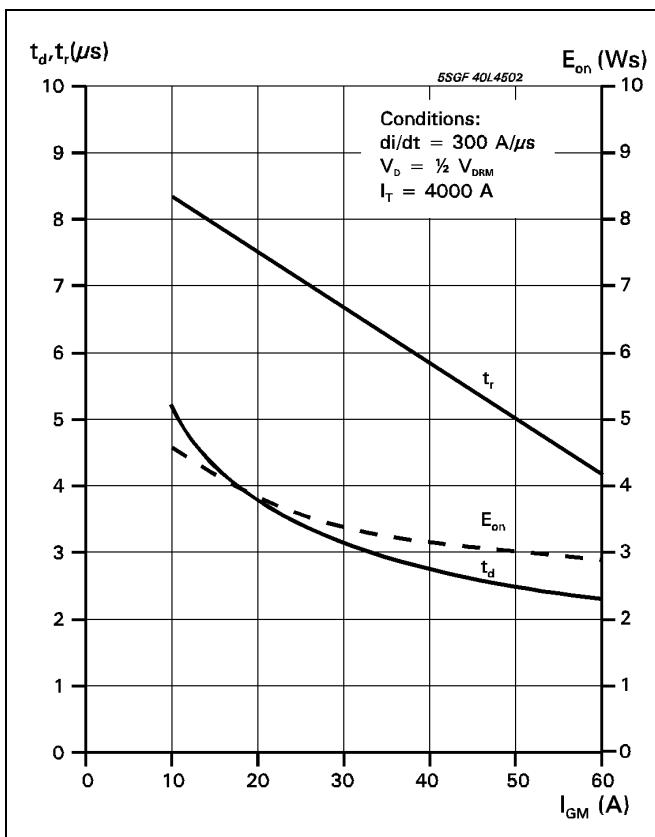
**Fig. 8** Gate trigger current vs. junction temperature



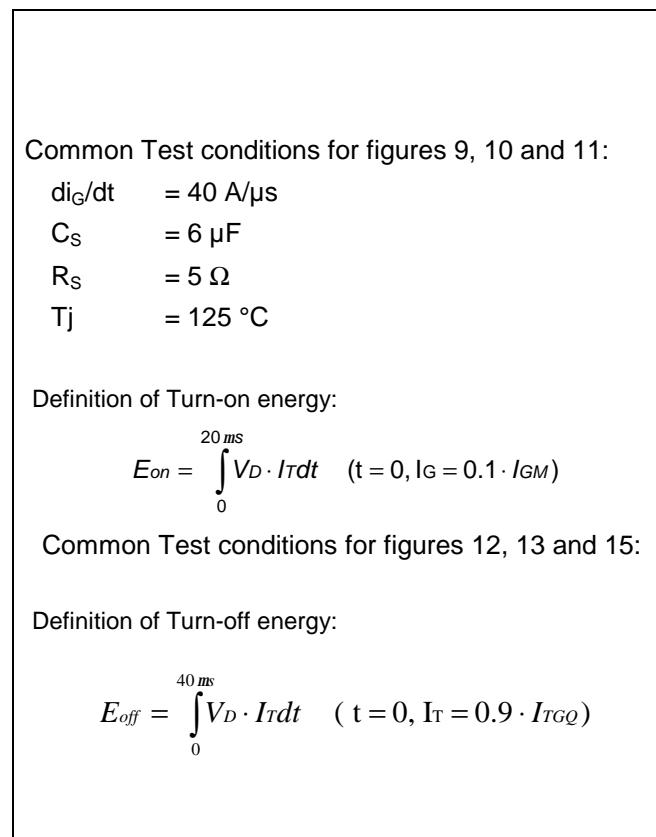
**Fig. 9** Turn-on energy per pulse vs. on-state current and turn-on voltage.

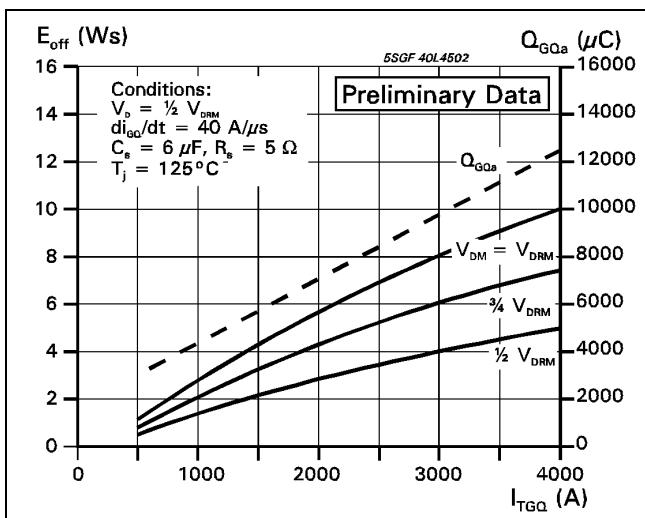


**Fig. 10** Turn-on energy per pulse vs. on-state current and current rise rate

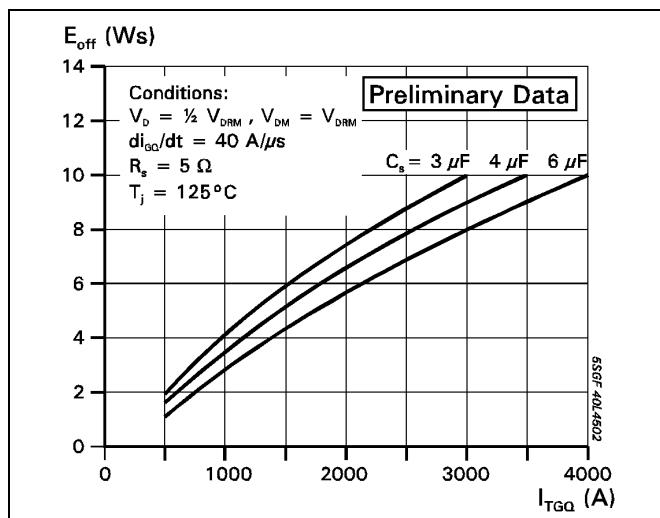


**Fig. 11** Turn-on energy per pulse vs. on-state current and turn-on voltage.

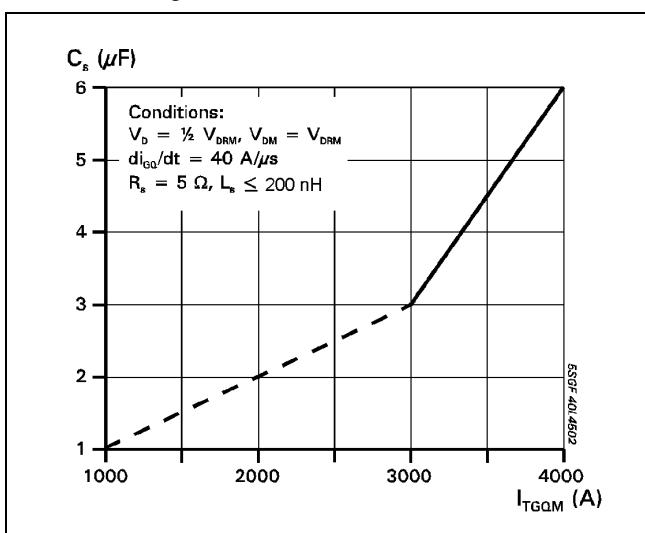




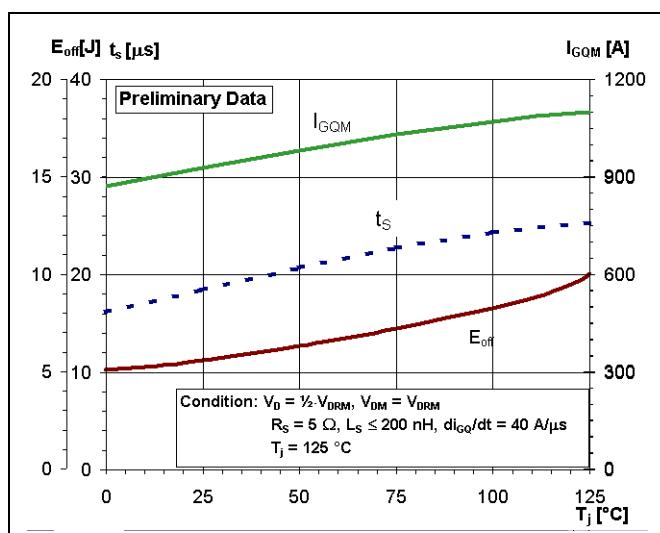
**Fig. 12** Turn-off energy per pulse vs. turn-off current and peak turn-off voltage. Extracted gate charge vs. turn-off current.



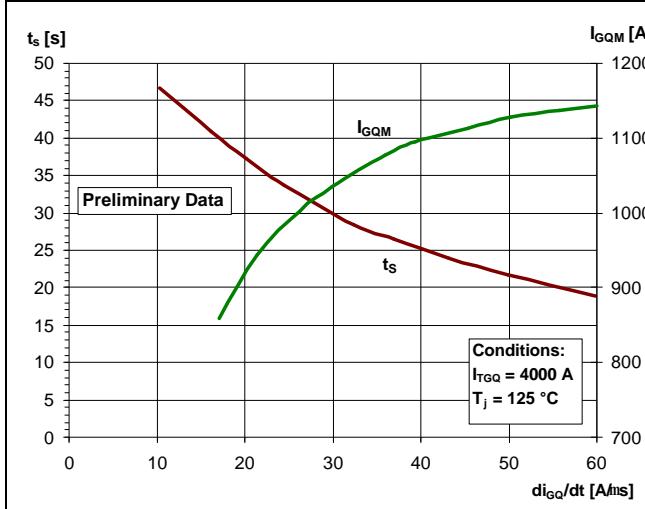
**Fig. 13** Turn-off energy per pulse vs. turn-off current and snubber capacitance.



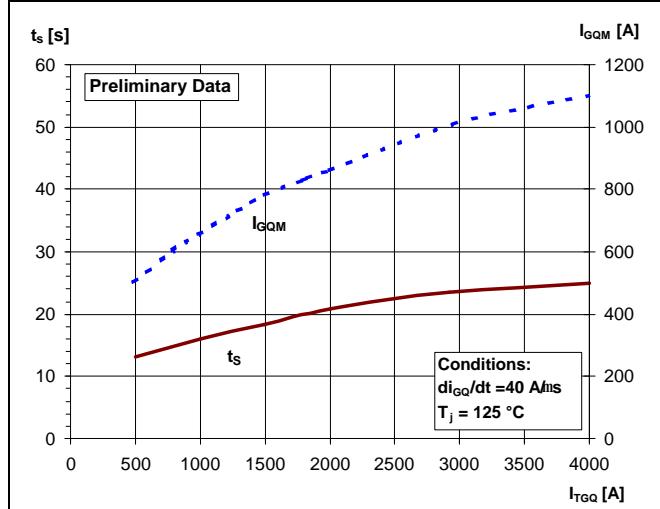
**Fig. 14** Required snubber capacitor vs. max allowable turn-off current.



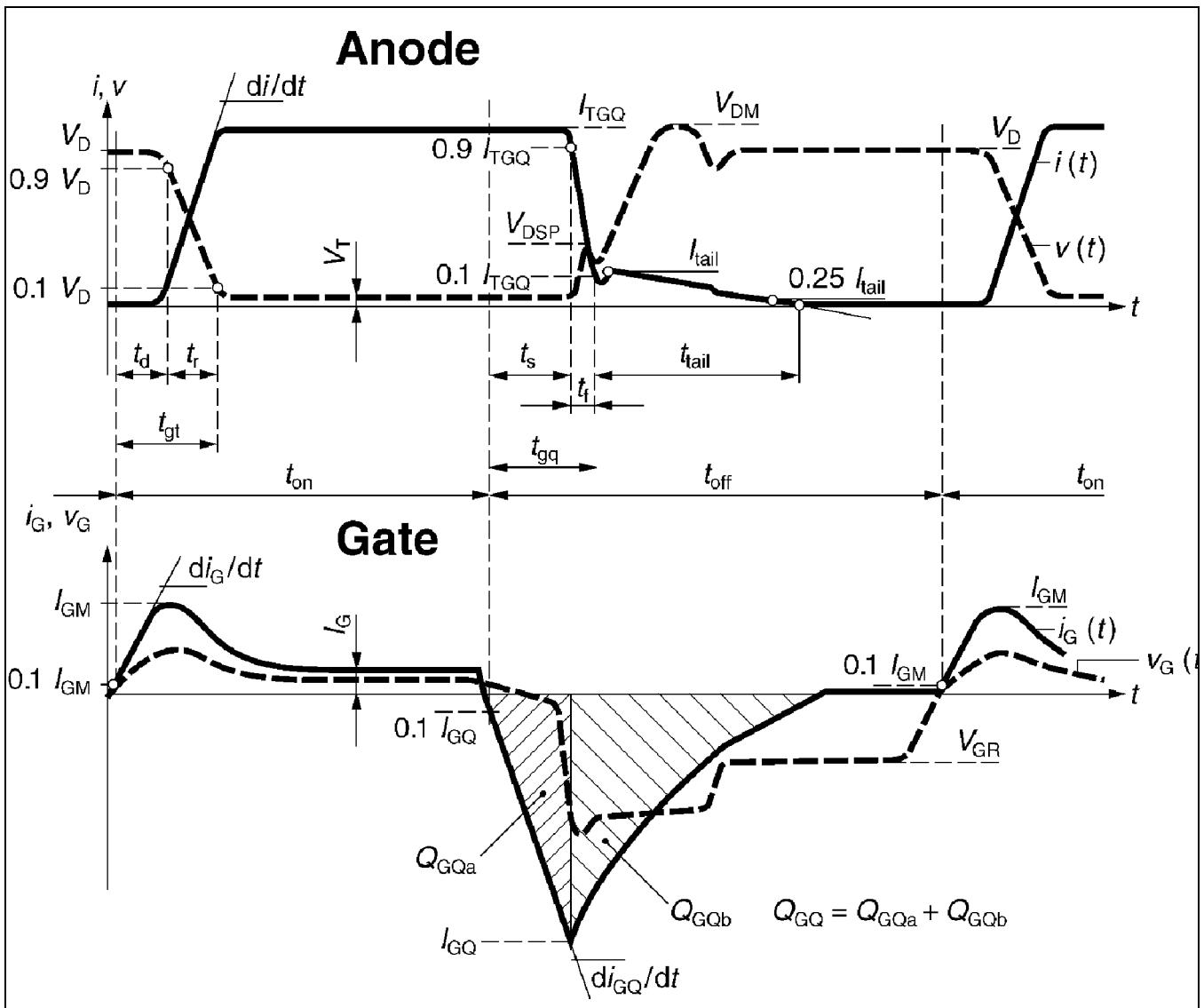
**Fig. 15** Turn-off energy per pulse, storage time and peak turn-off gate current vs. junction temperature.



**Fig. 16** Storage time and peak turn-off gate current vs. neg. gate current rise rate.



**Fig. 17** Storage time and peak turn-off gate current vs. turn-off current.



**Fig. 18** General current and voltage waveforms with GTO-specific symbols.

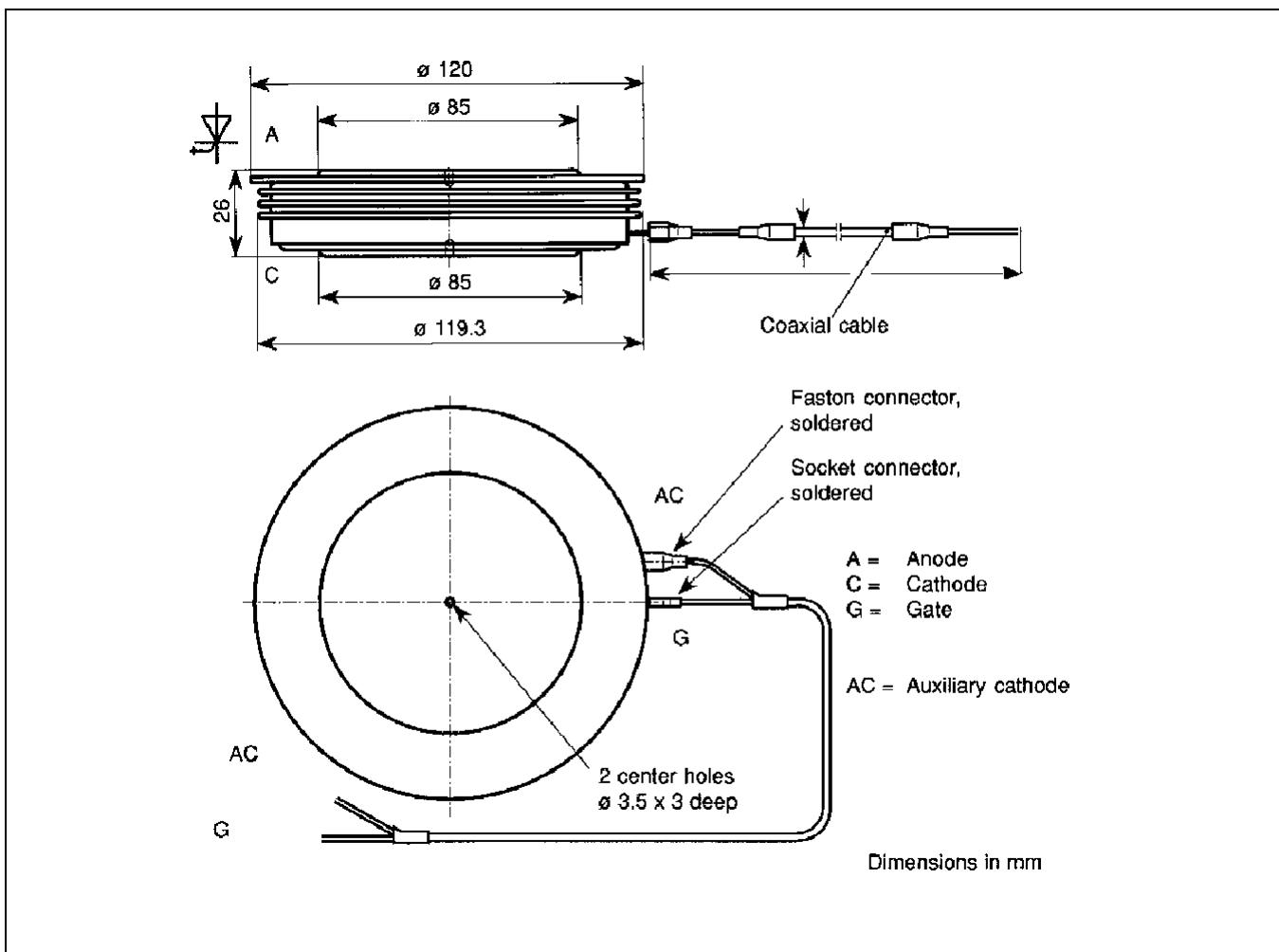


Fig. 19 Outline drawing. All dimensions are in millimeters and represent nominal values unless stated otherwise.

The 5SGF 40L4502 is a 91 mm buffered layer GTO with exceptionally low dynamic and static losses designed to retro-fit all former 4 kA GTOs of the same voltage. It offers optimal trade-off between on-state and switching losses and is encapsulated in an industry-standard press pack housing 120 mm wide and 26 mm thick.

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